

Datasheet

RoHS

Voltage Detector IC Series Standard CMOS Voltage Detector IC

BD48xxx series BD49xxx series

General Description

ROHM's BD48xxx and BD49xxx series are highly accurate, low-current Voltage Detector IC series. The family includes BD48xxx devices with N-channel open drain output and BD49xxx devices with CMOS output. The devices are available for specific detection voltages ranging from 2.3V to 6.0V in increments of 0.1V.

Features

High accuracy detection

Typical Application Circuit

- Ultra-low current consumption
- Two output types (Nch open drain and CMOS output)
- Wide Operating temperature range
- Very small and low height package
- Package SSOP5 is similar to SOT-23-5 (JEDEC)
- Package SSOP3 is similar to SOT-23-3 (JEDEC)

•Key Specifications

| Detection | voltage: | | 2.3V to 6.0V (Typ.), | | | | | |
|--------------------------------|----------------|-------------|----------------------|--|--|--|--|--|
| | | | 0.1V steps | | | | | |
| High accur | racy detection | on voltage: | ±1.0% | | | | | |
| Ultra-low c | current cons | umption: | 0.9µA (Typ.) | | | | | |
| Operating | temperature | e range: | -40°C to +105°C | | | | | |
| Package | Package | | | | | | | |
| SSOP5: | | 2.90mm > | x 2.80mm x 1.25mm | | | | | |
| SSOP3: | | 2.92mm > | 2.80mm x 1.25mm | | | | | |
| VSOF5: | And a | 1.60 mm > | (1.60mm x 0.60mm | | | | | |

Applications

Circuits using microcontrollers or logic circuits that require a reset.

VDD1 O-O VDD2 VDD1 O RL Micro BD49xxx Rst controller Micro BD48xxx RST controller CL C Capacitor for (Capacitor for noise filtering) noise filterina) GND O (Open Drain Output type) (CMOS Output type) BD48xxx series BD49xxx series

OProduct structure : Silicon monolithic integrated circuit OThis product is not designed for protection against radioactive rays

Connection Diagram SSOP5 N.C N.C. 4

Lot. No Marking 2 3 1 VDD GND Vout TOP VIEW

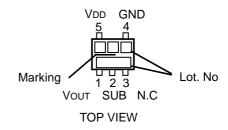
Pin Descriptions

| SSOP5 | | | | | |
|---------|--------|----------------------|--|--|--|
| PIN No. | Symbol | Function | | | |
| 1 | Vout | Reset Output | | | |
| 2 | Vdd | Power Supply Voltage | | | |
| 3 | GND | GND | | | |
| 4 | N.C. | Unconnected Terminal | | | |
| 5 | N.C. | Unconnected Terminal | | | |

VDD

3

VSOF5



| VSOF5 | | | | |
|---------|--------|----------------------|--|--|
| PIN No. | Symbol | Function | | |
| 1 | Vout | Reset Output | | |
| 2 | SUB | Substrate* | | |
| 3 | N.C. | Unconnected Terminal | | |
| 4 | GND | GND | | |
| 5 | Vdd | Power Supply Voltage | | |

GND

3

TOP VIEW

2

VDD

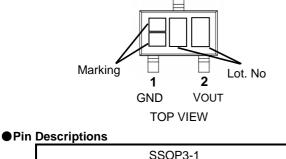
Lot. No

*Connect the substrate to GND.



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SSOP3(1pin GND)



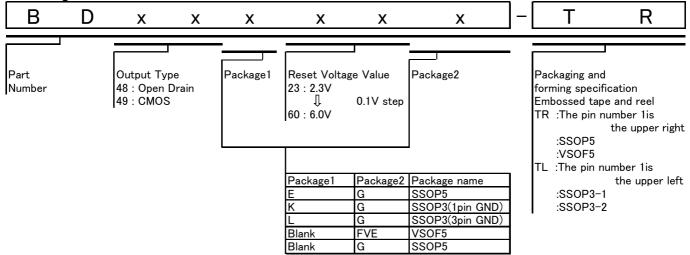
| | SSOP3-1 | | | | | | |
|------------|---------|--------|----------------------|--|--|--|--|
| PIN No. Sy | | Symbol | Function | | | | |
| | 1 | GND | GND | | | | |
| | 2 | Vout | Reset Output | | | | |
| | 3 | VDD | Power Supply Voltage | | | | |

| | SSC | DP3-2 | | |
|--------------|------|----------------------|--|--|
| PIN No. Symb | | Function | | |
| 1 | Vout | Reset Output | | |
| 2 | Vdd | Power Supply Voltage | | |
| 3 GND | | GND | | |
| | | | | |

1

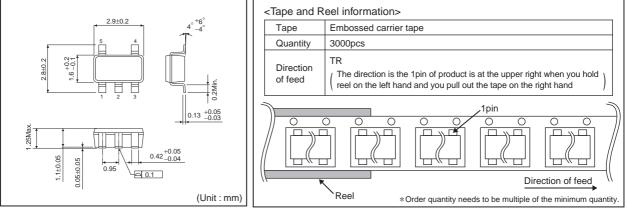
VOUT

Ordering Information

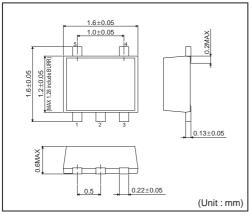


Note: When ordering new SSOP5, select "E" for Package 1 and "G" for Package 2.

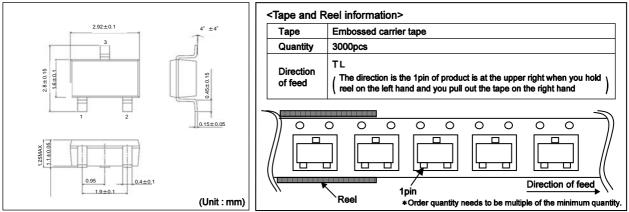
SSOP5



VSOF5







● Lineup

Table 1. Lineup for VSOF5 and SSOP5 Package

| Package Type | VSOF5 or SSOP5 | | | SSOP5 | | | | | |
|----------------------|----------------|-------------|---------|-----------------|---------|-------------|---------|-------------|--|
| Output Type | Ор | en Drain | (| CMOS Open Drain | | Open Drain | | CMOS | |
| Detection Voltage | Marking | Part Number | Marking | Part Number | Marking | Part Number | Marking | Part Number | |
| 6.0V | EW | BD4860 | GW | BD4960 | Cm | BD48E60 | Ff | BD49E60 | |
| 5.9V | EV | BD4859 | GV | BD4959 | Ck | BD48E59 | Fe | BD49E59 | |
| 5.8V | EU | BD4858 | GU | BD4958 | Ch | BD48E58 | Fd | BD49E58 | |
| 5.7V | ET | BD4857 | GT | BD4957 | Cg | BD48E57 | Fc | BD49E57 | |
| 5.6V | ES | BD4856 | GS | BD4956 | Cf | BD48E56 | Fb | BD49E56 | |
| 5.5V | ER | BD4855 | GR | BD4955 | Ce | BD48E55 | Fa | BD49E55 | |
| 5.4V | EQ | BD4854 | GQ | BD4954 | Cd | BD48E54 | Ey | BD49E54 | |
| 5.3V | EP | BD4853 | GP | BD4953 | Сс | BD48E53 | Er | BD49E53 | |
| 5.2V | EN | BD4852 | GN | BD4952 | Cb | BD48E52 | Ep | BD49E52 | |
| 5.1V | EM | BD4851 | GM | BD4951 | Ca | BD48E51 | En | BD49E51 | |
| 5.0V | EL | BD4850 | GL | BD4950 | By | BD48E50 | Em | BD49E50 | |
| 4.9V | EK | BD4849 | GK | BD4949 | Br | BD48E49 | Ek | BD49E49 | |
| 4.8V | EJ | BD4848 | GJ | BD4948 | Вр | BD48E48 | Eh | BD49E48 | |
| 4.7V | EH | BD4847 | GH | BD4947 | Bn | BD48E47 | Eg | BD49E47 | |
| 4.6V | EG | BD4846 | GG | BD4946 | Bm | BD48E46 | Ef | BD49E46 | |
| 4.5V | EF | BD4845 | GF | BD4945 | Bk | BD48E45 | Ee | BD49E45 | |
| 4.4V | EE | BD4844 | GE | BD4944 | Bh | BD48E44 | Ed | BD49E44 | |
| 4.3V | ED | BD4843 | GD | BD4943 | Bg | BD48E43 | Ec | BD49E43 | |
| 4.2V | EC | BD4842 | GC | BD4942 | Bf | BD48E42 | Eb | BD49E42 | |
| 4.1V | EB | BD4841 | GB | BD4941 | Be | BD48E41 | Ea | BD49E41 | |
| 4.0V | EA | BD4840 | GA | BD4940 | Bd | BD48E40 | Dy | BD49E40 | |
| 3.9V | DV | BD4839 | FV | BD4939 | Bc | BD48E39 | Dr | BD49E39 | |
| 3.8V | DU | BD4838 | FU | BD4938 | Bb | BD48E38 | Dp | BD49E38 | |
| 3.7V | DT | BD4837 | FT | BD4937 | Ва | BD48E37 | Dn | BD49E37 | |
| 3.6V | DS | BD4836 | FS | BD4936 | Ay | BD48E36 | Dm | BD49E36 | |
| 3.5V | DR | BD4835 | FR | BD4935 | Ar | BD48E35 | Dk | BD49E35 | |
| 3.4V | DQ | BD4834 | FQ | BD4934 | Ар | BD48E34 | Dh | BD49E34 | |
| 3.3V | DP | BD4833 | FP | BD4933 | An | BD48E33 | Dg | BD49E33 | |
| 3.2V | DN | BD4832 | FN | BD4932 | Am | BD48E32 | Df | BD49E32 | |
| 3.1V | DM | BD4831 | FM | BD4931 | Ak | BD48E31 | De | BD49E31 | |
| 3.0V | DL | BD4830 | FL | BD4930 | Ah | BD48E30 | Dd | BD49E30 | |
| 2.9V | DK | BD4829 | FK | BD4929 | Ag | BD48E29 | Dc | BD49E29 | |
| 2.8V | DJ | BD4828 | FJ | BD4928 | Af | BD48E28 | Db | BD49E28 | |
| 2.7V | DH | BD4827 | FH | BD4927 | Ae | BD48E27 | Da | BD49E27 | |
| 2.6V | DG | BD4826 | FG | BD4926 | Ad | BD48E26 | Су | BD49E26 | |
| 2.5V | DF | BD4825 | FF | BD4925 | Ac | BD48E25 | Cr | BD49E25 | |
| 2.4V | DE | BD4824 | FE | BD4924 | Ab | BD48E24 | Ср | BD49E24 | |
| 2.3V | DD | BD4823 | FD | BD4923 | Aa | BD48E23 | Cn | BD49E23 | |

Lineup - continued

Table 2. Lineup for SSOF3(1pin GND) and SSOP3(3pin GND) Package

| Package Type | SSOP3(1pin GND) | | | SSOP3(3pin GND) | | | | |
|----------------------|-----------------|-------------|---------|-----------------|------------|-------------|---------|-------------|
| Output Type | Open Drain | | CMOS | | Open Drain | | CMOS | |
| Detection Voltage | Marking | Part Number | Marking | Part Number | Marking | Part Number | Marking | Part Number |
| 6.0V | Cm | BD48K60 | Ff | BD49K60 | Kb | BD48L60 | Np | BD49L60 |
| 5.9V | Ck | BD48K59 | Fe | BD49K59 | Ka | BD48L59 | Nn | BD49L59 |
| 5.8V | Ch | BD48K58 | Fd | BD49K58 | Hy | BD48L58 | Nm | BD49L58 |
| 5.7V | Cg | BD48K57 | Fc | BD49K57 | Hr | BD48L57 | Nk | BD49L57 |
| 5.6V | Cf | BD48K56 | Fb | BD49K56 | Нр | BD48L56 | Nh | BD49L56 |
| 5.5V | Ce | BD48K55 | Fa | BD49K55 | Hn | BD48L55 | Ng | BD49L55 |
| 5.4V | Cd | BD48K54 | Ey | BD49K54 | Hm | BD48L54 | Nf | BD49L54 |
| 5.3V | Сс | BD48K53 | Er | BD49K53 | Hk | BD48L53 | Ne | BD49L53 |
| 5.2V | Cb | BD48K52 | Ep | BD49K52 | Hh | BD48L52 | Nd | BD49L52 |
| 5.1V | Ca | BD48K51 | En | BD49K51 | Hg | BD48L51 | Nc | BD49L51 |
| 5.0V | By | BD48K50 | Em | BD49K50 | Hf | BD48L50 | Nb | BD49L50 |
| 4.9V | Br | BD48K49 | Ek | BD49K49 | He | BD48L49 | Na | BD49L49 |
| 4.8V | Вр | BD48K48 | Eh | BD49K48 | Hd | BD48L48 | My | BD49L48 |
| 4.7V | Bn | BD48K47 | Eg | BD49K47 | Hc | BD48L47 | Mr | BD49L47 |
| 4.6V | Bm | BD48K46 | Ef | BD49K46 | Hb | BD48L46 | Мр | BD49L46 |
| 4.5V | Bk | BD48K45 | Ee | BD49K45 | Ha | BD48L45 | Mn | BD49L45 |
| 4.4V | Bh | BD48K44 | Ed | BD49K44 | Gy | BD48L44 | Mm | BD49L44 |
| 4.3V | Bg | BD48K43 | Ec | BD49K43 | Gr | BD48L43 | Mk | BD49L43 |
| 4.2V | Bf | BD48K42 | Eb | BD49K42 | Gp | BD48L42 | Mh | BD49L42 |
| 4.1V | Be | BD48K41 | Ea | BD49K41 | Gn | BD48L41 | Mg | BD49L41 |
| 4.0V | Bd | BD48K40 | Dy | BD49K40 | Gm | BD48L40 | Mf | BD49L40 |
| 3.9V | Bc | BD48K39 | Dr | BD49K39 | Gk | BD48L39 | Me | BD49L39 |
| 3.8V | Bb | BD48K38 | Dp | BD49K38 | Gh | BD48L38 | Md | BD49L38 |
| 3.7V | Ba | BD48K37 | Dn | BD49K37 | Gg | BD48L37 | Мс | BD49L37 |
| 3.6V | Ay | BD48K36 | Dm | BD49K36 | Gf | BD48L36 | Mb | BD49L36 |
| 3.5V | Ar | BD48K35 | Dk | BD49K35 | Ge | BD48L35 | Ма | BD49L35 |
| 3.4V | Ар | BD48K34 | Dh | BD49K34 | Gd | BD48L34 | Ky | BD49L34 |
| 3.3V | An | BD48K33 | Dg | BD49K33 | Gc | BD48L33 | Kr | BD49L33 |
| 3.2V | Am | BD48K32 | Df | BD49K32 | Gb | BD48L32 | Кр | BD49L32 |
| 3.1V | Ak | BD48K31 | De | BD49K31 | Ga | BD48L31 | Kn | BD49L31 |
| 3.0V | Ah | BD48K30 | Dd | BD49K30 | Fy | BD48L30 | Km | BD49L30 |
| 2.9V | Ag | BD48K29 | Dc | BD49K29 | Fr | BD48L29 | Kk | BD49L29 |
| 2.8V | Af | BD48K28 | Db | BD49K28 | Fp | BD48L28 | Kh | BD49L28 |
| 2.7V | Ae | BD48K27 | Da | BD49K27 | Fn | BD48L27 | Kg | BD49L27 |
| 2.6V | Ad | BD48K26 | Су | BD49K26 | Fm | BD48L26 | Kf | BD49L26 |
| 2.5V | Ac | BD48K25 | Cr | BD49K25 | Fk | BD48L25 | Ke | BD49L25 |
| 2.4V | Ab | BD48K24 | Ср | BD49K24 | Fh | BD48L24 | Kd | BD49L24 |
| 2.3V | Aa | BD48K23 | Cn | BD49K23 | Fg | BD48L23 | Kc | BD49L23 |

Absolute Maximum Ratings

| | Parameter | Symbol | Limits | Unit |
|-----------------------|-----------------------|---------------|---------------------------------|------|
| Power Supply Vo | Itage | V_{DD} -GND | -0.3 to +10 | V |
| | Nch Open Drain Output | M | GND-0.3 to +10 | V |
| Output Voltage | CMOS Output | Vout | GND-0.3 to V _{DD} +0.3 | V |
| Output Current | | lo | 70 | mA |
| Daviar | SSOP5 *1*4 | | 540 | |
| Power | SSOP3 *2*4 | Pd | 700 | mW |
| Dissipation | VSOF5 *3*4 | | 210 | |
| Operating Temperature | | Topr | -40 to +105 | °C |
| Ambient Storage | Temperature | Tstg | -55 to +125 | °C |

*1 Reduced by 5.4mW/°C when used over 25°C.

*2 Reduced by 7.0mW/°C when used over 25°C.

*3 Reduced by 2.1mW/°C when used over 25°C.

*4 When mounted on ROHM standard circuit board (70mm×70mm×1.6mm, glass epoxy board).

●Electrical Characteristics (Unless Otherwise Specified, Ta=-40 to 105°C)

| Parameter | Sympol | Condition | | | Limit | | Unit |
|--------------------------|-----------|--|----------------------------|-------------------------------|----------------------|-------------------------------|-------------|
| Parameter | Symbol | | | Min. | Тур. | Max. | Unit |
| | | R∟=470kΩ, Vdd=H→ | ۰L *۱ | V _{DET} (T) ×0.99 | V _{DET} (T) | V _{DET} (T) ×1.01 | |
| | | | Ta=+25°C | 2.475 | 2.5 | 2.525 | |
| | | VDET=2.5V | Ta=-40°C to 85°C | 2.418 | - | 2.584 | |
| | | | Ta=85°C to 105°C | 2.404 | - | 2.597 | |
| | | | Ta=+25°C | 2.970 | 3.0 | 3.030 | |
| | | VDET=3.0V | Ta=-40°C to 85°C | 2.901 | - | 3.100 | |
| | | | Ta=85°C to 105°C | 2.885 | - | 3.117 | |
| Detection Voltage | V_{DET} | | Ta=+25°C | 3.267 | 3.3 | 3.333 | V |
| | | VDET=3.3V | Ta=-40°C to 85°C | 3.191 | - | 3.410 | |
| | | | Ta=85°C to 105°C | 3.173 | - | 3.428 | · · · |
| | | | Ta=+25°C | 4.158 | 4.2 | 4.242 | |
| | | VDET=4.2V | Ta=-40°C to 85°C | 4.061 | - | 4.341 | |
| | | | Ta=85°C to 105°C | 4.039 | - | 4.364 | |
| | | VDET=4.8V | Ta=+25°C | 4.752 | 4.8 | 4.848 | |
| | | | Ta=-40°C to 85°C | 4.641 | - | 4.961 | |
| | | | Ta=85°C to 105°C | 4.616 | - | 4.987 | |
| Output Delay Time "L→H" | tPLH | C∟=100pF R ∟=100k Vout=GND-→50% | Ω *2 | - | - | 100 | μs |
| | | | V _{DET} =2.3-3.1V | - | 0.51 | 1.53 | |
| | | | V _{DET} =3.2-4.2V | - | 0.56 | 1.68 | |
| Circuit Current when ON | Icc1 | VDD=V _{DET} -0.2V | V _{DET} =4.3-5.2V | - | 0.60 | 1.80 | μA |
| | | | V _{DET} =5.3-6.0V | - | 0.66 | 1.98 | |
| | | | V _{DET} =2.3-3.1V | - | 0.75 | 2.25 | |
| Circuit Current when OFF | 1000 | V | V _{DET} =3.2-4.2V | - | 0.80 | 2.40 | |
| | Icc2 | VDD=V _{DET} +2.0V ^{*1} | V _{DET} =4.3-5.2V | - | 0.85 | 2.55 | μA |
| | | | V _{DET} =5.3-6.0V | - | 0.90 | 2.70 | |
| Operating Voltage Bange | Vos | VoL≤0.4V, Ta=25 to ² | 105°C, R∟=470kΩ | 0.95 | - | - | V |
| Operating Voltage Range | Vopl | Vo∟≤0.4V, Ta=-40 to | 25°C, RL=470kΩ | 1.20 | - | - | v |

 $V_{DET}(T)$: Standard Detection Voltage(2.3V to 6.0V, 0.1V step) R_L : Pull-up resistor to be connected between VouT and power supply. C_L : Capacitor to be connected between VouT and GND. Design Guarantee. (Outgoing inspection is not done on all products.) *1 Guaranteed at Ta=25°C.

*2 tPLH:VDD=(V_{DET} typ.-0.5V)→(V_{DET} typ.+0.5V)

● Electrical Characteristics (Unless Otherwise Specified, Ta=-40 to 105°C) - continued

| Deremeter | Symbol Condition | | | Unit | | |
|------------------------------|-------------------------|--|----------------------------------|----------------------|-----------------------------|--------|
| Parameter | Symbol | Condition | Min. | Тур. | Max. | Unit |
| (Low/Output) (oltogo (Nich) | Mai | VDD=1.5V, ISINK = 0.4 mA, VDET=2.3-6.0V | - | - | 0.5 | v |
| 'Low'Output Voltage (Nch) | Vol | VDD=2.4V, ISINK = 2.0 mA, VDET=2.7-6.0V | - | - | 0.5 | v |
| (Lligh)Output Valtage (Deb) | | VDD=4.8V, ISOURCE=0.7 mA, VDET(2.3V to 4.2V) | VDD-0.5 | - | - | |
| 'High'Output Voltage (Pch) | Vон | VDD=6.0V, ISOURCE=0.9 mA, VDET(4.3V to 5.2V) | VDD-0.5 | - | - | V |
| (BD49Exxx Series) | | VDD=8.0V, ISOURCE=1.1 mA, VDET(5.3V to 6.0V) | VDD-0.5 | - | - | |
| Leak Current when OFF | I | VDD=VDS=10V | | | 0.1 | |
| (BD48xxx Series) | leak | VDD=VDS=10V | - | - | 0.1 | μA |
| Detection Voltage | V _{DET} /ΔT | Ta=-40°C to 105°C | | ±100 | ±360 | nnm/°C |
| Temperature coefficient | V DET/ A I | (Designed Guarantee) | - | ±100 | ±300 | ppm/°C |
| Hysteresis Voltage | ΔV_{DET} | VDD=L→H→L, RL=470kΩ | $V_{\text{DET}} \mathbf{x} 0.03$ | $V_{DET} 	imes 0.05$ | $V_{\text{DET}} 	imes 0.08$ | V |

 $V_{\text{DET}}(T): \text{Standard Detection Voltage}(2.3V \text{ to } 6.0V, 0.1V \text{ step}) \\ R_{L}: \text{Pull-up resistor to be connected between VOUT and power supply.} \\ C_{L}: \text{ Capacitor to be connected between VOUT and GND.} \\ \text{Design Guarantee. (Outgoing inspection is not done on all products.)} \\ *1 \text{ Guaranteed at Ta=25°C.} \\ \end{array}$

Block Diagrams

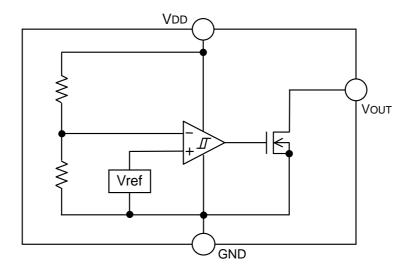


Fig.1 BD48xxx series

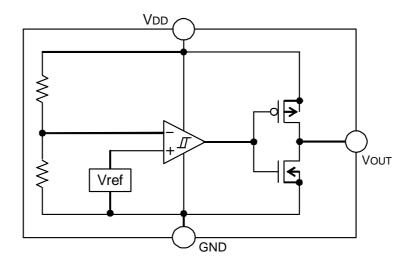
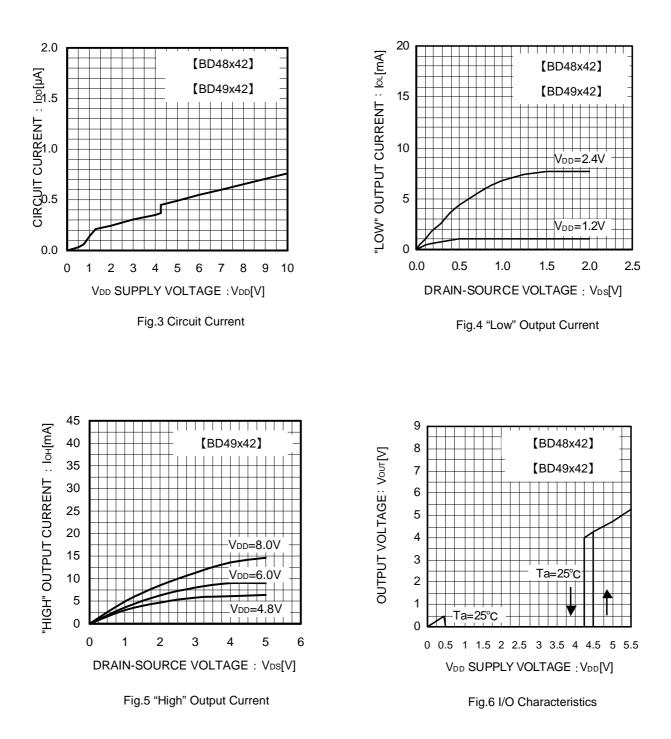


Fig.2 BD49xxx series

Typical Performance Curves



● Typical Performance Curves – continued

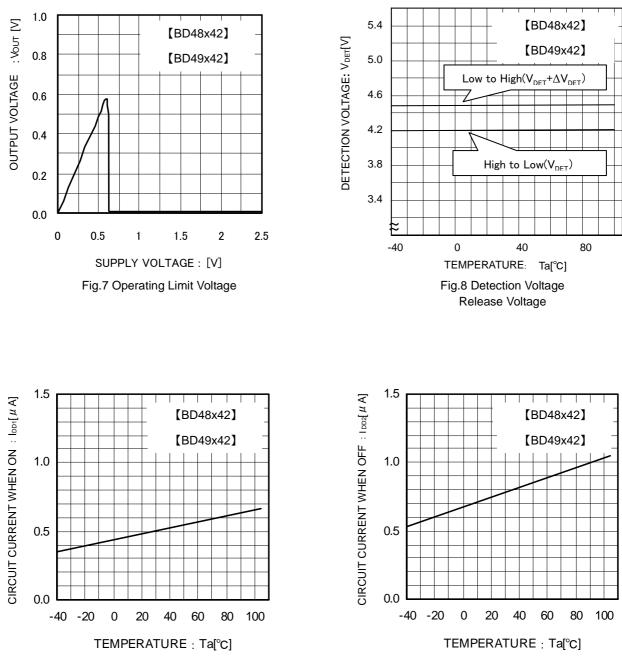


Fig.9 Circuit Current when ON

Fig.10 Circuit Current when OFF

●Typical Performance Curves – continued

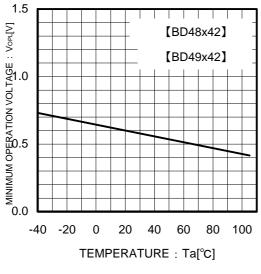


Fig.11 Operating Limit Voltage

Application Information

Explanation of Operation

For both the open drain type (Fig.12) and the CMOS output type (Fig.13), the detection and release voltages are used as threshold voltages. When the voltage applied to the V_{DD} pins reaches the appropriate threshold voltage, the V_{OUT} terminal voltage switches from either "High" to "Low" or from "Low" to "High". Please refer to the Timing Waveform and Electrical Characteristics for information on hysteresis.

Because the BD48xxx series uses an open drain output type, it is necessary to connect a pull-up resistor to V_{DD} or another power supply if needed [The output "High" voltage (V_{OUT}) in this case becomes V_{DD} or the voltage of the other power supply].

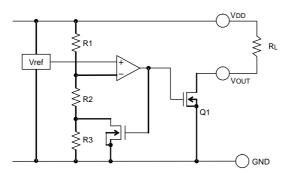


Fig.12 (BD48xxx series Internal Block Diagram)

Reference Data

Examples of Leading (tPLH) and Falling (tPHL) Output

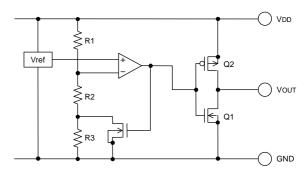


Fig.13 (BD49xxx series Internal Block Diagram)

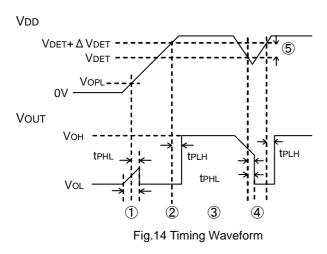
| Part Number | t _{PLH} (μs) | t _{PHL} (μs) | | | | | |
|-------------|-----------------------|-----------------------|--|--|--|--|--|
| BD48x45 | 39.5 | 87.8 | | | | | |
| BD49x45 | 32.4 | 52.4 | | | | | |
| | Vpp=4.3V→5.1V | Vpp=5 1V→4 3V | | | | | |

*These data are for reference only.

The figures will vary with the application, so please check actual operating conditions before use.

Timing Waveform

Example: the following shows the relationship between the input voltages V_{DD} and the output voltage V_{OUT} when the input power supply voltage V_{DD} swept up and down (the circuits are those in Fig.12 and 13).



⁽¹⁾ When the power supply is turned on, the output is unstable from after over the operating limit voltage (VOPL) until tPHL. Therefore it is possible that the reset signal is not outputted when the rise time of V_{DD} is faster than tPHL.

⁽²⁾ When V_{DD} is greater than V_{OPL} but less than the reset release voltage (V_{DET} + Δ V_{DET}), the output voltages will switch to Low.

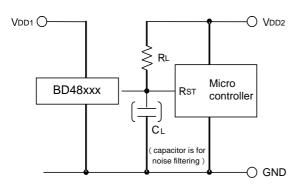
 $^{(3)}$ If V_{DD} exceeds the reset release voltage (V_{DET} + ΔV_{DET}), then V_{OUT} switches from L to H.

⁽⁴⁾ If V_{DD} drops below the detection voltage (V_{DET}) when the power supply is powered down or when there is a power supply fluctuation, V_{OUT} switches to L (with a delay of t_{PHL}).

⁽⁵⁾ The potential difference between the detection voltage and the release voltage is known as the hysteresis width (ΔV_{DET}). The system is designed such that the output does not toggle with power supply fluctuations within this hysteresis width, preventing malfunctions due to noise.

Circuit Applications

1) Examples of a common power supply detection reset circuit.





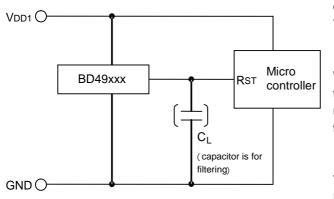


Fig.16 CMOS Output Type

Application examples of BD48xxx series (Open Drain output type) and BD49xxx series (CMOS output type) are shown on the left.

CASE1: Power supply of the microcontroller (V_{DD2}) differs from the power supply of the reset detection IC (V_{DD1}).

Use an open drain output type (BD48xxx) device with a load resistance R_L attached as shown in figure 15.

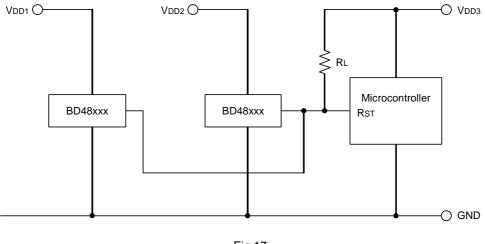
CASE2: Power supply of the microcontroller (V_{DD1}) is same as the power supply of the reset detection IC (V_{DD1}).

Use a CMOS output type (BD49xxx) device or an open drain device with a pull up resistor between output and VDD1.

When a capacitance C_L for noise filtering is connected to the V_{OUT} pin (the reset signal input terminal of the microcontroller), please take into account the rise and fall waveform of the output voltage (V_{OUT}).

The Electrical characteristics were measured using R_L = 470k Ω and C_L = 100pF.

2) The following is an example of a circuit application in which an OR connection between two types of detection voltage resets the microcontroller.





To reset the microcontroller when many independent power supplies are used in the system, OR connect an open drain output type (BD48xxx series) to the microcontroller's input with pull-up resistor to the supply voltage of the microcontroller (V_{DD3}) as shown in Fig. 17. By pulling-up to V_{DD3} , output "High" voltage of micro-controller power supply is possible.

3) Examples of the power supply with resistor dividers

In applications wherein the power supply voltage of an IC comes from a resistor divider circuit, an in-rush current will flow into the circuit when the output level switches from "High" to "Low" or vice versa. In-rush current is a sudden surge of current that flows from the power supply (VDD) to ground (GND) as the output logic changes its state. This current flow may cause malfunction in the systems operation such as output oscillations, etc.

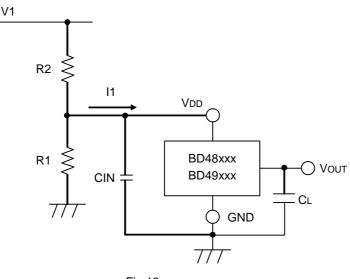


Fig.18

When an in-rush current (I1) flows into the circuit (Refer to Fig. 18) at the time when output switches from "Low" to "High", a voltage drop of I1×R2 (input resistor) will occur in the circuit causing the VDD supply voltage to decrease. When the VDD voltage drops below the detection voltage, the output will switch from "High" to "Low". While the output voltage is at "Low" condition, in-rush current will stop flowing and the voltage drop will be reduced. As a result, the output voltage will switches again from "Low" to "High" which causes an in-rush current and a voltage drop. This operation repeats and will result to oscillation.

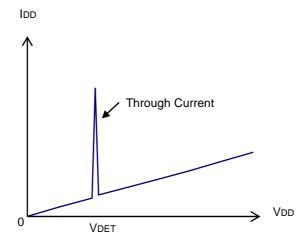


Fig.19 Current Consumption vs. Power Supply Voltage

Operational Notes

1) Absolute maximum ratings

Operating the IC over the absolute maximum ratings may damage the IC. The damage can either be a short circuit between pins or an open circuit between pins. Therefore, it is important to consider circuit protection measures, such as adding a fuse, in case the IC is operated over the absolute maximum ratings.

- 2) Ground Voltage The voltage of the ground pin must be the lowest voltage of all pins of the IC at all operating conditions. Ensure that no pins are at a voltage below the ground pin at any time, even during transient condition.
- Recommended operating conditions
 These conditions represent a range within which the expected characteristics of the IC can be approximately obtained.
 The electrical characteristics are guaranteed under the conditions of each parameter.
- Bypass Capacitor for Noise Rejection To help reject noise, put a 1µF capacitor between VDD pin and GND and 1000pF capacitor between VOUT pin and GND. Be careful when using extremely big capacitor as transient response will be affected.
- 5) Short between pins and mounting errors Be careful when mounting the IC on printed circuit boards. The IC may be damaged if it is mounted in a wrong orientation or if pins are shorted together. Short circuit may be caused by conductive particles caught between the pins.
- 6) Operation under strong electromagnetic field Operating the IC in the presence of a strong electromagnetic field may cause the IC to malfunction.
- 7) The V_{DD} line impedance might cause oscillation because of the detection current.
- 8) A V_{DD} to GND capacitor (as close connection as possible) should be used in high VDD line impedance condition.
- 9) Lower than the mininum input voltage puts the VOUT in high impedance state, and it must be VDD in pull up (VDD) condition.
- 10) External parameters

The recommended parameter range for R_L is $10k\Omega$ to $1M\Omega$. There are many factors (board layout, etc) that can affect characteristics. Please verify and confirm using practical applications.

11) Power on reset operation

Please note that the power on reset output varies with the V_{DD} rise time. Please verify the behavior in the actual operation.

12) Testing on application boards

When testing the IC on an application board, connecting a capacitor directly to a low-impedance output pin may subject the IC to stress. Always discharge capacitors completely after each process or step. The IC's power supply should always be turned off completely before connecting or removing it from the test setup during the inspection process. To prevent damage from static discharge, ground the IC during assembly and use similar precautions during transport and storage.

13) Rush current

When power is first supplied to the IC, rush current may flow instantaneously. It is possible that the charge current to the parasitic capacitance of internal photo diode or the internal logic may be unstable. Therefore, give special consideration to power coupling capacitance, power wiring, width of GND wiring, and routing of connections.

14) This IC has extremely high impedance terminals. Small leak current due to the uncleanness of PCB surface might cause unexpected operations. Application values in these conditions should be selected carefully. If $10M\Omega$ leakage is assumed between the C_T terminal and the GND terminal, $1M\Omega$ connection between the CT terminal and the V_{DD} terminal would be recommended. Also, if the leakage is assumed between the Vout terminal and the GND terminal, the pull up resistor should be less than 1/10 of the assumed leak resistance.

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 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
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- 2. In principle, the reflow soldering method must be used; if flow soldering method is preferred, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
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- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
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| Unit Quantity | 3000 |
| Minimum Package Quantity | 3000 |
| Packing Type | Taping |
| Constitution Materials List | inquiry |
| RoHS | Yes |